What is claimed is:

1. An optoelectronic device comprising:

an active region;

a semiconductor region;

a tunnel junction between the active region and the semiconductor region; and

a current blocking region between the active region and the semiconductor region, wherein the current blocking region operates as a reversed biased PN junction and confines a current between the active region and the semiconductor region to the current through the tunnel junction.

- 2. The device of claim 1, wherein the current blocking region comprises a portion of the tunnel junction in which tunneling has been disabled.
- 3. The device of claim 1, wherein the current blocking region comprises a portion of the tunnel junction that contains an additional implant that disables tunneling.
- 4. The device of claim 1, wherein the current blocking region comprises a portion of the tunnel junction that contains additional dopants that disable tunneling.
- 5. The device of claim 1, wherein the current blocking region comprises a portion of the tunnel junction that has a disrupted crystal structure.
 - 6. The device of claim 1, wherein:

the tunnel junction comprises a heavily doped p-type region and a heavily doped n-type region between the active region and the semiconductor region; and

the current blocking region comprises a structure that is the same as that of the tunnel junction, except that at least one of the heavily doped p-type region and the heavily doped n-type region is missing from the current blocking region.

7. The device of claim 1, wherein the current blocking region comprises a portion of the tunnel junction that has been partially diffused

- 8. The device of claim 1, wherein the current blocking region comprises a portion of the tunnel junction that has been partially diffused by impurity-induced disordering
- 9. The device of claim 1, wherein the current blocking region comprises a portion of the tunnel junction that has been partially diffused by impurity-free disordering
- 10. The device of claim 1, wherein the optoelectronic device is a vertical cavity surface emitting laser.
 - 11. A method for fabricating an optoelectronic device, comprising:

forming an active region and a semiconductor region with a tunnel junction between the active region and the semiconductor region; and

disabling tunneling in a selected part of the tunnel junction to form a current blocking region, wherein during operation of the optoelectronic device the tunnel junction conducts a current between the active region and the semiconductor region and the current blocking region acts as a reverse biased PN junction to block current.

- 12. The method of claim 11, wherein disabling tunneling comprises ion implantation into the selected part of the tunnel junction.
 - 13. The method of claim 12, wherein the implanted species comprise n-type dopants.
 - 14. The method of claim 12, wherein the implanted species comprise p-type dopants.
- 15. The method of claim 12, wherein the implanted species comprise an ion that reduces the conductivity of the material into which it is implanted
- 16. The method of claim 11, wherein disabling tunneling comprises disrupting the crystal structure in the selected part of the tunnel junction.

- 17. The method of claim 11, wherein disabling the tunneling comprises partially diffusing the tunnel junction via impurity-induced disordering
- 18. The method of claim 11, wherein disabling the tunneling comprises partially diffusing the tunnel junction via impurity-free disordering.
- 19. The method of claim 11, wherein the optoelectronic device is a vertical cavity surface emitting laser.